

Atty. Docket No. CPAC 1014-4
Appl. No. 10/608,843

PATENT

JPW /

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Taekun LEE

Application No.: 10/608,843

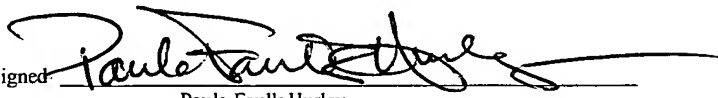
Filed: June 27, 2003

Title: **Plastic ball grid array with integral
heatsink**

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) Examiner: Khiem D. Nguyen
)
) Group Art Unit: 2823
)
) Date: December 8, 2004

) CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first class mail in an envelope addressed to: MS Amendment, Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on December 8, 2004.

Signed: 
Paula Faulk Hurley

MAILSTOP AMENDMENT
COMMISSIONER FOR PATENTS
P.O BOX 1450
ALEXANDRIA, VA 22313-1450

AMENDMENT

Dear Sir:

In response to the Office action mailed June 15, 2004, kindly amend the application as follows.

Amendments to the claims are reflected in the **Listing of Claims** which begins on page 2 of this paper.

Remarks begin on page 5 of this paper.